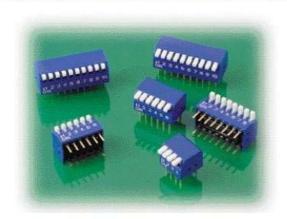
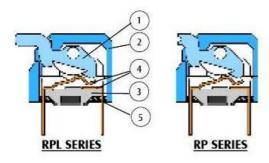
# RPL.RP Series

# PIANO TYPE DIP SWITCH

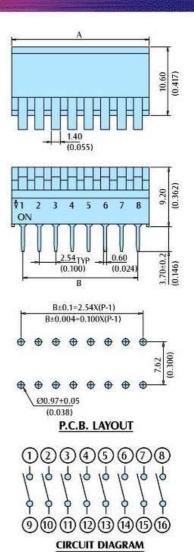


## **RPL & RP CONSTRUCTION**

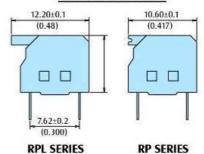


- Terminal plating by gold gives excellent results when soldering.
- RPL series (raised actuator) and RP series (recessed actuator)
- Low contact resistance, and self-clean on contact area.
- 4. Double contacts offer high reliability.
- 5. All materials are UL94V-0 grade fire retardant plastics.

ITEM	Description	Materials	Treatment
1	Actuator	UL94V-0 PBT	White
		Thermoplastic	
2	Cover	UL94V-0 PBT	Blue, Red,
		Thermoplastic	Black
3	Base	UL94V-0 PBT	Black
		Thermoplastic	
4	Terminal Contact	Phosphor bronze	Gold Plating
5	Potting	Epoxy	Black



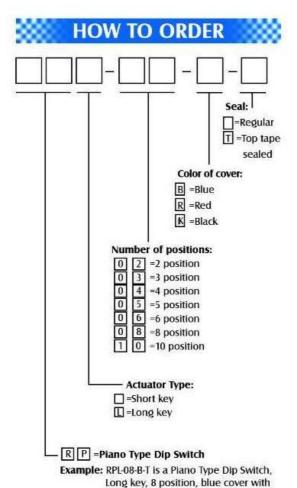
# TERMINAL TYPE





### MODEL

PART NO.	NO. OF POS	DIM A	
RPL/RP-02	02	6.26	0.246
RPL/RP-03	03	9.06	0.357
RPL/RP-04	04	11.34	0.446
RPL/RP-05	05	13.88	0.546
RPL/RP-06	06	16.42	0.646
RPL/RP-08	08	21.5	0.846
RPL/RP-10	10	26.58	1.046



#### **PACKING**

All Dip Switches are shipped in standard IC tubes with all poles in "OFF" position.

top tape sealed.

## **SPECIFICATION**

#### **ELECTRICAL**

Electrical life: 2000 operation cycles per switch 24VDC, 25mA.

Non-Switching Rating: 100mA, 50 VDC Switching Rating: 25mA, 24VDC.

Contact resistance: (a)  $50m\Omega$  max. at initial

(b)  $100m\Omega$  max. after life test.

Insulation resistance:  $100M\Omega$  min. (at 500VDC)

Dielectric Strength: 500VAC/1 minute.

Capacitance: 5pF max.

Circuit: Single pole single throw

#### MECHANICAL

Mechanical life: 2000 operations per cycle switch

Operation Force: 400gf max.

Stroke: 2.0mm

Operation Temp: -20° C to +70° C Storage Temp: -40° C to +85° C

Vibration Test: MIL-STD-202F METHOD 201A Frequency: 10-55-10Hz/1 min Directions: X, Y, Z, three mutually perpendicular directions. Time: 2 hours each direction.

High reliability.

Shock Test: MIL-STD-202F METHOD 213B.

CONDITION A

GRAVITY: 50G (peak value), 11 m/sec.

Direction and times: 6 sides and three times in

each direction. High reliability.

#### **SOLDERING AND CLEANING PROCESSES**

For best results, please follow these recommendations: Keep all switch contacts in their 'OFF' position for all operations.

WAVE SOLDERING: Recommended solder temperature at 500

F (260° C) max. 5 seconds.

HAND SOLDERING: Use a soldering iron of 30 watts, controlled at 608 F(320° C) approximately 2 seconds

while applying solder.

CLEANING PROCESS: Flux clean using force rinse, high agitation or triple bath cleaning method. Freon TF or TE give excellent results. When vapor methods are used, do not subject the switch to solvents at temperatures above 125 F (51° C).

